TROPIC01

OD_TR01_catalog_list

Catalog list

Version: 0.4

Abstract

This Document lists all delivered Part Numbers of TROPIC01 and their configuration.

September 16, 2025



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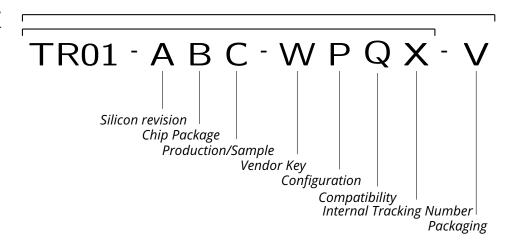
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1 Part Number

Ordering Code Part Number



| Label | Description | | |
|-------|---|--|--|
| Α | Silicon replacedevision | | |
| | A - ABAA - Pre-production samples (Bootloader version 1.0.1) | | |
| | B - ABAB - Pre-production samples (Bootloader version 1.0.1) | | |
| | C - ACAB - Production devices (Bootloader version 2.0.1) | | |
| В | Chip Package | | |
| | 1 - No package, bare silicon die | | |
| | 2 - QFN32 (4x4mm, 32L T/SLP) | | |
| С | Production/Sample | | |
| | P - Production device | | |
| | S - Sample device | | |
| W | Vendor Key | | |
| | T - Tropic Square vendor key | | |
| | P - Tropic Square vendor key (legacy) | | |
| | E - Unspecified external vendor key | | |
| | X - Tropic Square development key | | |
| | U - No key or undefined key | | |
| Р | Configuration | | |
| | 0 I/R Config are empty (see 5.1) | | |
| | 1 Sensors are enabled in I-Config (see 5.2) | | |
| | 2 Sensors are enabled in I-Config, MBIST is enabled (see 5.3) | | |
| | 3 Sensors are enabled in I-Config, MBIST is enabled, FW logging is disabled. (see 5.4) | | |

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| Label | Description | |
|-------|--|--|
| Q | Compatibility | |
| | 0 - L2/L3 API compatible with Application FW 1.0.0. | |
| X | Internal Tracking Number | |
| | Tropic Square Internal Tracking Number. Keep as "X" when ordering. | |
| V | Packaging | |
| | A - 13" reel (330mm), MOQ 5000 units | |
| | B - 7" reel (177.8mm), MOQ 1500 units | |
| | C - reel strip, MOQ 100 units | |
| | D - custom reel, MOQ 500 units | |
| | T - tray, MOQ 490 units | |

1.1 Ordering details

Part Number scheme above captures all differences between TROPIC01 chips delivered. The **X** digit is used for internal tracking purposes. Customers shall keep "X" as a character for these two digits when specifying order code of TROPIC01, e.g.:

TR01-C2P-T30X-A

Silicon Rev. C (ACAB) - production, QFN32, Configuration as in 5.4, Compatibility with Application FW 1.0.0, 5000 pcs reel.

TR01-B1S-T10X-T

Silicon Rev. B (ABAB)- sample, Bare die, Configuration as in 5.2, Compatibility with Application FW 1.0.0, tray.

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2 Available Part Numbers

Below is a list of Part Numbers that have been released.

| Part Number | Ordering Code |
|---------------|-----------------|
| TR01-B2S-T005 | TR01-B2S-T00X-V |
| TR01-C2P-T103 | TR01-C2P-T10X-V |
| TR01-C2P-T101 | TR01-C2P-T10X-V |
| TR01-C2P-T202 | TR01-C2P-T20X-V |
| TR01-C2P-T301 | TR01-C2P-T30X-V |

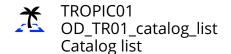
Note

"V" shall be replaced to define type of chip packaging (reel, tray, etc..) as defined in 1.

Note

In addition to these Part Numbers, there exist pre-production samples that do not follow Part Number Scheme described above. Such devices are not supported.

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3 Package Marking

See below sections to understand TROPIC01 package markings.

3.1 Marking Version 1

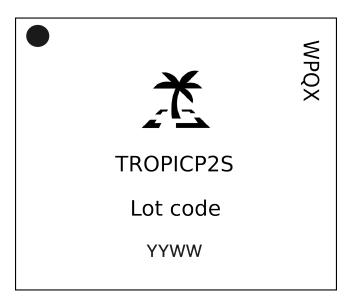


Figure 1: Package Marking Version 1

| Item Name | Meaning |
|-----------|---------------------------------------|
| TROPICP2S | Product label |
| Lot code | Silicon manufacturer lot code |
| YY | Last two numbers of the year when the |
| | chip was packaged |
| WW | Week number within year when the chip |
| | was packaged, zero padded |
| W | Vendor Key indicator, see 1 |
| P | Configuration, see 1 |
| Q | Compatiblity, see 1 |
| X | Internal tracking code |

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3.2 Marking Version 1.5



Figure 2: Package Marking Version 1.5

| Item Name | Meaning |
|-----------|---------------------------------------|
| | |
| TROPICP2S | Product label |
| Lot code | Silicon manufacturer lot code |
| YY | Last two numbers of the year when the |
| | chip was packaged |
| WW | Week number within year when the chip |
| | was packaged, zero padded |
| W | Vendor Key indicator, see 1 |
| P | Configuration, see 1 |
| Q | Compatiblity, see 1 |
| X | Internal tracking code |

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3.3 Marking Version 2

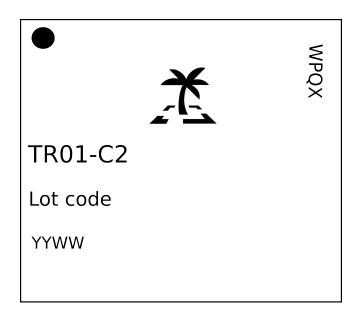


Figure 3: Package Marking Version 2

| Item Name | Meaning |
|-----------|---|
| TR01-C2 | Prefix of Part Number, see 1 |
| Lot code | Silicon manufacturer lot code |
| YY | Last two numbers of the year when the chip was packaged |
| WW | Week number within year when the chip was packaged, zero padded |
| W | Vendor Key indicator, see 1 |
| P | Configuration, see 1 |
| Q | Compatiblity, see 1 |
| X | Internal tracking code |



4 Shipment Labeling

The shipments made by Tropic Square are labeled with the following sticker:

Item: TROPIC01 **tropicsquare

P/N: TR01-C2P-T101-C **Date code:** 2510

Marking: TROPICP2S MSL: 3

Package: QFN32 4x4mm

Qty: 185 pcs.

Diffused in: Singapore **Prov. in:** Czech Rep. **Made in:** Malaysia

Lot code: S64PQ.65

Prod idn: 2025-05-09T11-00-29Z__prod_C2P_T101__provisioning__eps_

TR01-C2P-T101-Brno_20250513_132001.ppkg



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RoHS 3 Compliant:

Figure 4: Package Sticker

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5 Factory Configuration

This section provides the default configuration for each Part Number of TROPIC01 that Tropic Square programs to R/I-Config during manufacturing (Letter P in Part Number scheme). The table lists all CO Fields that are set to 0. The rest have the default value 1.

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5.1 T0XX

| R-Config | I-Config |
|----------|----------|

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5.2 T1XX

| R-Config | I-Config |
|--------------------------|----------|
| CFG_SENSORS | |
| - CPB_BIT_FLIP_DIS | |
| - CPU_ALERT_DIS | |
| - ECC_BIT_FLIP_DIS | |
| - EKDB_BIT_FLIP_DIS | |
| - EM_PULSE_DET_DIS | |
| - GLITCH_DET_DIS | |
| - I_MEM_BIT_FLIP_DIS | |
| - LASER_DET_DIS | |
| - OSCILLATOR_MON_DIS | |
| - PIN_VERIF_BIT_FLIP_DIS | |
| - PLATFORM_BIT_FLIP_DIS | |
| - PTRNG0_TEST_DIS | |
| - PTRNG1_TEST_DIS | |
| - R_MEM_BIT_FLIP_DIS | |
| - SCB_BIT_FLIP_DIS | |
| - SHIELD_DIS | |
| - TEMP_SENS_DIS | |
| - VOLTAGE_MON_DIS | |

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5.3 T2XX

| R-Config | I-Config |
|--------------------------|---------------|
| CFG_SENSORS | CFG_START_UP |
| - CPB_BIT_FLIP_DIS | - MBIST_DIS |
| - CPU_ALERT_DIS | - RNGTEST_DIS |
| - ECC_BIT_FLIP_DIS | |
| - EKDB_BIT_FLIP_DIS | |
| - EM_PULSE_DET_DIS | |
| - GLITCH_DET_DIS | |
| - I_MEM_BIT_FLIP_DIS | |
| - LASER_DET_DIS | |
| - OSCILLATOR_MON_DIS | |
| - PIN_VERIF_BIT_FLIP_DIS | |
| - PLATFORM_BIT_FLIP_DIS | |
| - PTRNG0_TEST_DIS | |
| - PTRNG1_TEST_DIS | |
| - R_MEM_BIT_FLIP_DIS | |
| - SCB_BIT_FLIP_DIS | |
| - SHIELD_DIS | |
| - TEMP_SENS_DIS | |
| - VOLTAGE_MON_DIS | |

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5.4 T3XX

| R-Config | I-Config |
|--------------------------|---------------|
| CFG_SENSORS | CFG_DEBUG |
| - CPB_BIT_FLIP_DIS | - FW_LOG_EN |
| - CPU_ALERT_DIS | CFG_START_UP |
| - ECC_BIT_FLIP_DIS | - MBIST_DIS |
| - EKDB_BIT_FLIP_DIS | - RNGTEST_DIS |
| - EM_PULSE_DET_DIS | |
| - GLITCH_DET_DIS | |
| - I_MEM_BIT_FLIP_DIS | |
| - LASER_DET_DIS | |
| - OSCILLATOR_MON_DIS | |
| - PIN_VERIF_BIT_FLIP_DIS | |
| - PLATFORM_BIT_FLIP_DIS | |
| - PTRNG0_TEST_DIS | |
| - PTRNG1_TEST_DIS | |
| - R_MEM_BIT_FLIP_DIS | |
| - SCB_BIT_FLIP_DIS | |
| - SHIELD_DIS | |
| - TEMP_SENS_DIS | |
| - VOLTAGE_MON_DIS | |

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Version history

| Version | Date | Description |
|---------|-----------|---|
| 0.1 | 5.9.2025 | Initial version |
| 0.2 | 8.9.2025 | Split NUM into C and XX. Replace X Y Z by A B C. |
| 0.3 | 10.9.2025 | Introduce Compatibility flag. |
| 0.4 | 11.9.2025 | Introduce Package Marking v1.5. |

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